505441715 04/23/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5488516

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HAYATO HIRAYAMA	03/08/2018

RECEIVING PARTY DATA

Name:	KYOCERA DOCUMENT SOLUTIONS INC.	
Street Address:	1-2-28, TAMATSUKURI, CHUO-KU	
City:	OSAKA	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15924055

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	HORI_16_MAR_2018_HH	
NAME OF SUBMITTER:	AME OF SUBMITTER: NATHAN FEDDE	
SIGNATURE:	/Nathan Fedde/	
DATE SIGNED:	04/23/2019	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 2

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PATENT 505441715 REEL: 048973 FRAME: 0546

DECLARATION AND ASSIGNMENT FOR PATENT AND DESIGN APPLICATIONS

発明の名称 Title of Invention MTF MEASURING METHOD FOR MEASURING MTF OF CONTACT IMAGE SENSORS, AND MTF ADJUSTING METHOD

特許出願宣言書

下記の氏名の発明者として、私は以下の通り宣言します

本宣誓は 添付されている、あるいは

上記の出願は私自身、あるいは私が権限を授与したものによっ て行われたものです。

私は本出願書中にあらわれるもともとの発明者、あるいはもともとの共同発明者です。

本宣誓書において故意に虚偽の申し立てを行った場合は 18 U.S.C. 1001 により、罰金あるいは最高五(5)年の禁固刑、あるいはその両方による罰則の対象となることを認めます。

Declaration For Patent Application

As a below-named inventor, I hereby declare that:

This declaration is directed to: the attached application.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Assignment

WHEREAS I, a below-named inventor, having citizenship and mailing address as set forth below with the signature block,

have invented or co-invented one or more inventions for which an application for a non-provisional Letters Patent of the United States having the above-identified title, and which is filed on or about 16 March 2018 (said one or more inventions and said application hereinafter referred to individually and collectively as "INVENTIONS"), and claiming priority to Japan patent application number 2017-050847, which was filed on 16 March 2017,

WHEREAS, KYOCERA Document Solutions Inc., operating under the laws of the Japan, and having a place of business at 1-2-28, Tamatsukuri, Chuo-ku, Osaka-shi, Osaka, 540-8585 Japan (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring my entire interest therein;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell, assign, and transfer and set over, unto said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under INVENTIONS and all divisions, renewals, and continuations thereof, and all patents of the United States which may be granted thereon and all reissues, reexaminations and extensions thereof; and all Patents of the United States which may be granted thereon and all applications for industrial property protection, including, without limitation, all applications

PATENT REEL: 048973 FRAME: 0547 for patents, utility models, and designs which may hereafter be filed for INVENTIONS in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from INVENTIONS under Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models and designs, which may be granted for INVENTIONS in any country or countries foreign to the United States and all extensions, renewals, reexaminations and reissues thereof;

I HEREBY authorize and requests the Commissioner of Patents and Trademarks of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

I HEREBY grant Hawaii Patent Services the power to insert in this Assignment any further identification or information which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

I HEREBY further covenant and agree to communicate to ASSIGNEE, its successors, legal representatives and assigns, any facts known respecting INVENTIONS, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, reexamination and foreign applications, make all rightful oaths, and generally do everything possible to aid ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for INVENTIONS in all countries.

In witness whereof, executed by me on the date opposite my name.

Legal name of inventor:	
Inventor's Signature:	Havato HIRAYAMA
Date: Mar 8, 2018	

Date: Mar. 8, 2018

Citizenship: Japan

RECORDED: 04/23/2019

Mailing Address: 1-2-28, Tamatsukuri, Chuo-ku, Osaka-shi, Osaka, 540-8585 JAPAN

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